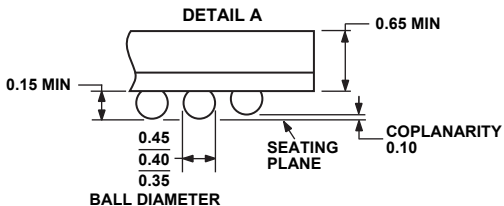
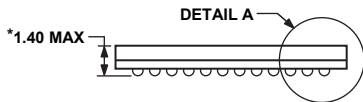
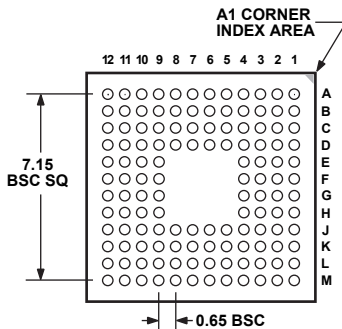
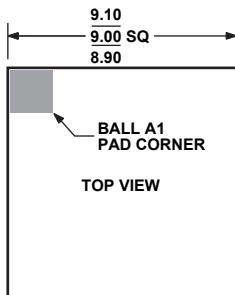


**128-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]  
(BC-128)**

Dimensions shown in millimeters



**\*COMPLIANT TO JEDEC STANDARDS MO-225  
WITH THE EXCEPTION TO PACKAGE HEIGHT.**